STM32Cube function pack for IoT node with BLE connectivity and environmental and motion sensors

Features

- Complete firmware to develop an IoT node with BLE connectivity, environmental and motion sensors
- Middleware libraries for sensor data fusion and accelerometer-based real-time activity recognition, carry position, gesture recognition, motion intensity recognition and pedometer
- Compatible with STBLESensor applications for Android/iOS, to perform sensor data reading, motion algorithm features demo and firmware update (FOTA)
- Sample implementations available for the X-NUCLEO-IKS01A2 (or X-NUCLEO-IKS01A3), P-NUCLEO-IKA02A1 and X-NUCLEO-IDB05A2 connected to a NUCLEO-F401RE or NUCLEO-L476RG or NUCLEO-L053R8 board
- Easy portability across different MCU families, thanks to STM32Cube
- Free, user-friendly license terms

Description

FP-SNS-MOTENV1 is an STM32Cube function pack, which lets you connect your IoT node to a smartphone via BLE and uses a suitable Android™ or iOS™ application, such as the STBLESensor app, to view real-time motion and environmental (such as temperature, relative humidity, carbon monoxide) sensor data.

This package also enables advanced functions such as the sensor data fusion and accelerometer-based real-time activity recognition, carry position, gesture recognition, motion intensity recognition and real-time information about the number of steps and cadence which the user just performed with the device, i.e. cell phone. Together with the suggested combination of STM32 and ST devices, it can be used to develop specific wearable and environmental applications, or smart things applications in general.

The software runs on the STM32 microcontroller and includes all the necessary drivers to recognize the devices on the STM32 Nucleo development board and expansion boards.
1 Detailed description

1.1 What can you do with STM32Cube function packs?

STM32Cube function packs leverage the modularity and interoperability of STM32 Nucleo and X-NUCLEO boards together with STM32Cube and X-CUBE software to create function examples for some of the most common use cases of different application technologies.

These software function packs are designed to exploit the underlying STM32 ODE hardware and software components as much as possible to best satisfy the requirements of final user applications.

Moreover, function packs may include additional libraries and frameworks that are not present in the original X-CUBE packages, thus enabling new functionalities allowing real and usable system for developers.

1.2 What is STM32Cube?

STM32Cube is a combination of a full set of PC software tools and embedded software blocks running on STM32 microcontrollers and microprocessors:

- **STM32CubeMX** configuration tool for any STM32 device; it generates initialization C code for Cortex-M cores and the Linux device tree source for Cortex-A cores
- **STM32CubeIDE** integrated development environment based on open-source solutions like Eclipse or the GNU C/C++ toolchain, including compilation reporting features and advanced debug features
- **STM32CubeProgrammer** programming tool that provides an easy-to-use and efficient environment for reading, writing and verifying devices and external memories via a wide variety of available communication media (JTAG, SWD, UART, USB DFU, I2C, SPI, CAN, etc.)
- **STM32CubeMonitor family of tools** (STM32CubeMonRF, STM32CubeMonUCPD, STM32CubeMonPwr) to help developers customize their applications in real-time
- **STM32Cube MCU and MPU packages** specific to each STM32 series with drivers (HAL, low-layer, etc.), middleware, and lots of example code used in a wide variety of real-world use cases
- **STM32Cube expansion packages** for application-oriented solutions

1.2.1 How does this software complement STM32Cube?

This software is based on the STM32CubeHAL. It extends STM32Cube by providing a board support package (BSP) for the BlueNRG-MS network processor (embedded in the BlueNRG-M0 module), sensor expansion board and middleware components for communication with other BLE devices and for sensor data fusion.

This package also contains motion sensor libraries useful for sensing applications based on BLE communication: MotionFX, MotionAR, MotionCP, MotionGR, MotionID, MotionPM.

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**RELATED LINKS**

Visit the X-CUBE-MEMS1 web page on www.st.com for further information on the motion sensor libraries

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## Revision history

<table>
<thead>
<tr>
<th>Date</th>
<th>Version</th>
<th>Changes</th>
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<tbody>
<tr>
<td>17-Feb-2016</td>
<td>1</td>
<td>Initial release.</td>
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</table>
| 13-Apr-2016| 2       | Updated cover page Features  
Added NUCLEO-L053R8 compatibility information |
| 22-Jul-2016| 3       | Added STEVAL-STLKT01V1 compatibility information  
Added FOTA information  
Added reference to Gas Gauge for STEVAL-STLC501V1 |
| 14-Dec-2016| 4       | Updated title, cover image, cover page Features and Description  
Added X-NUCLEO-IKS01A2 compatibility information |
| 02-Mar-2017| 5       | Updated cover page Features and Description, and How does this software complement STM32Cube? |
| 20-Jul-2017| 6       | Updated cover image, features, description and logo in cover page. |
| 27-Oct-2017| 7       | Updated cover image, features, description and How does this software complement STM32Cube? |
| 08-Mar-2018| 8       | Updated cover image.  
Added P-NUCLEO-IKA02A1 compatibility information. |
| 04-Dec-2019| 9       | Updated cover page image, product summary table, features and description.  
Updated Section 1.2 What is STM32Cube?.  
Added X-NUCLEO-IKS01A3 expansion board compatibility information. |
| 10-Jun-2020| 10      | Added X-NUCLEO-IDB05A2 compatibility information. |
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